



DMP3045LFVWQ

## **Product Summary**

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Max Tc = +25°C
001/	42mΩ @ V <sub>GS</sub> = -10V	-19.9A
-30V	65mΩ @ V <sub>GS</sub> = -4.5V	-16A

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power Management Functions
- DC-DC Converters

## 30V P-CHANNEL ENHANCEMENT MODE MOSFET

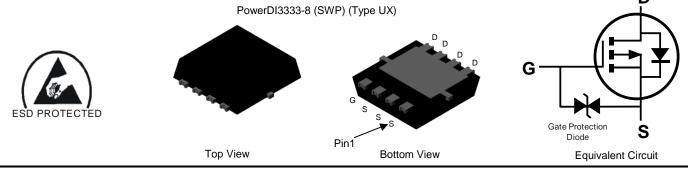
### **Features and Benefits**

- Low RDS(ON) Ensures On-State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP3045LFVWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Package: PowerDI<sup>®</sup>3333-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.072 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Nulliper	Fackage	Qty.	Carrier	
DMP3045LFVWQ-7	PowerDI3333-8 (SWP) (Type UX)	2,000	Tape & Reel	
DMP3045LFVWQ-13	PowerDI3333-8 (SWP) (Type UX)	3,000	Tape & Reel	

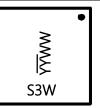
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



 $\frac{S3W}{YY} = Product Type Marking Code$  $\frac{YY}{YY}WW = Date Code Marking$  $\frac{YY}{YY} = Last Two Digits of Year (ex: 21 = 2021)$ WW = Week Code (01 to 53)

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#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			Vdss	-30	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-5.7 -4.6	А
Continuous Drain Current (Note 7) $V_{GS} = -10V$	Steady State	Tc = +25°C Tc = +70°C	ID	-19.9 -15.9	А
Maximum Continuous Body Diode Forward Current (Note 7)			ls	-1.3	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1		Ідм	-76	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I <sub>SM</sub>	-76	А
Avalanche Current (Note 8) L = 1mH			las	-7.8	А
Avalanche Energy (Note 8) L = 1mH			Eas	30.8	mJ

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	Po	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	135	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	61	°C/W
Thermal Resistance, Junction to Case (Note 7)	R <sub>θJC</sub>	5	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	—	—	V	$V_{GS} = 0V, I_{D} = -250 \mu A$
Zero Gate Voltage Drain Current	IDSS	—	—	-1	μA	$V_{DS} = -24V$ , $V_{GS} = 0V$
Gate-Source Leakage	IGSS		—	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	—	-2.1	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
Static Drain-Source On-Resistance	Descer	—	25	42	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -4.9A
	RDS(ON)	—	43	65	11152	VGS = -4.5V, ID = -3.7A
Diode Forward Voltage	Vsd	—	-0.7	-1.2	V	$V_{GS} = 0V$ , $I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	782	—	pF	
Output Capacitance	Coss	_	110	_	pF	VDS = -15V, VGS = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	74	—	pF	
Gate Resistance	Rg	—	10.4	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	—	6.6	—	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	13.6	—	nC	
Gate-Source Charge	Qgs	_	2.1	—	nC	V <sub>DS</sub> = -15V, I <sub>D</sub> = -4.9A
Gate-Drain Charge	Q <sub>gd</sub>	_	2.7	—	nC	
Turn-On Delay Time	tD(ON)	_	4.1	—	ns	
Turn-On Rise Time	t <sub>R</sub>	_	6.1	—	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	tD(OFF)		24.6	—	ns	I <sub>D</sub> = -4.9A, R <sub>G</sub> = 6Ω
Turn-Off Fall Time	tF	—	13.1	—	ns	
Reverse Recovery Time	t <sub>RR</sub>	—	12.7	_	ns	
Reverse Recovery Charge	QRR	_	4.8	—	nC	Is = -11.5A, dl/dt = 100A/µs

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

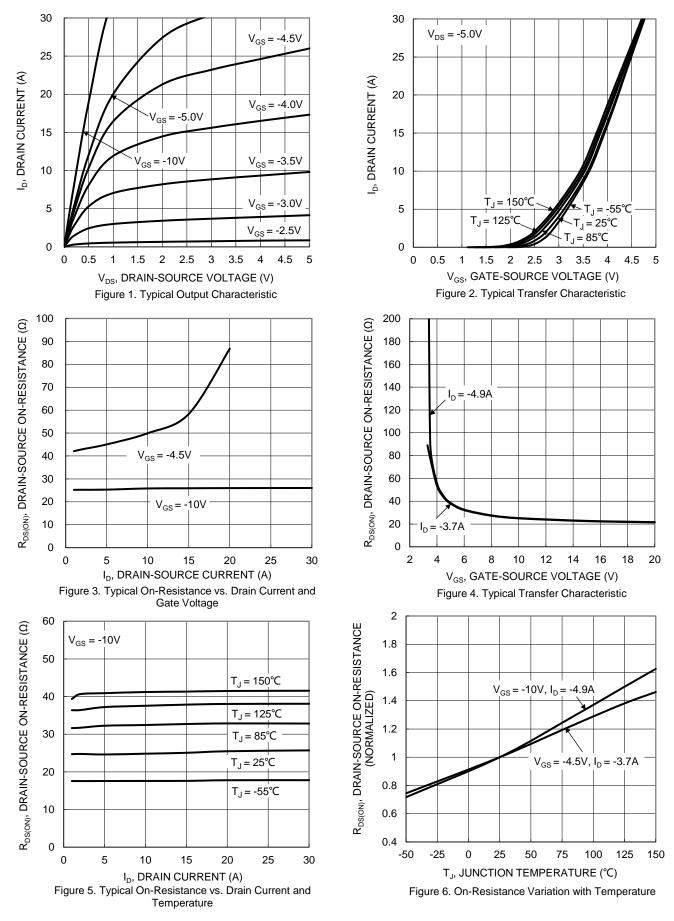
7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I<sub>AS</sub> and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

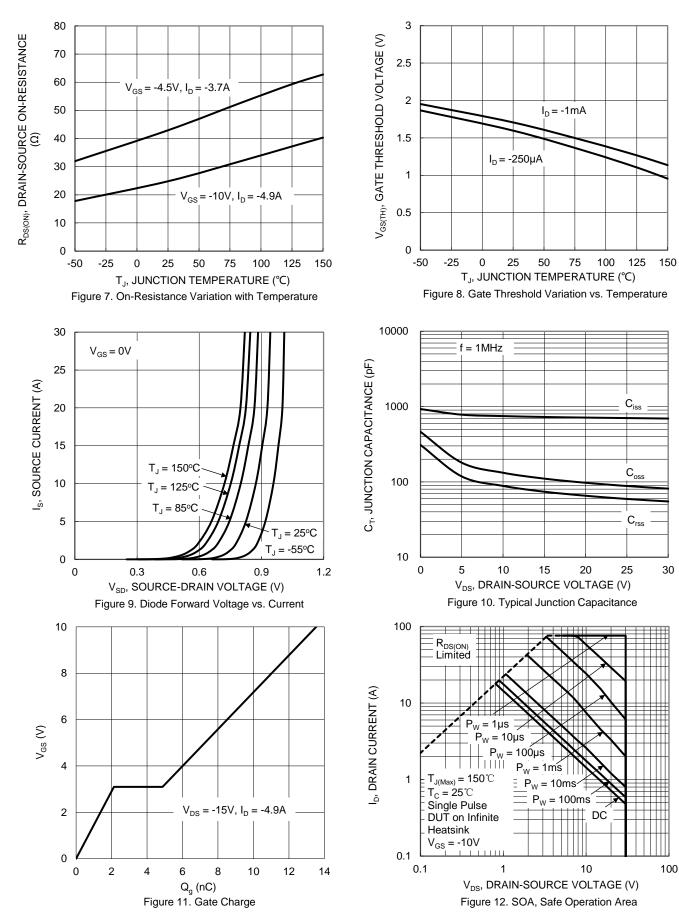




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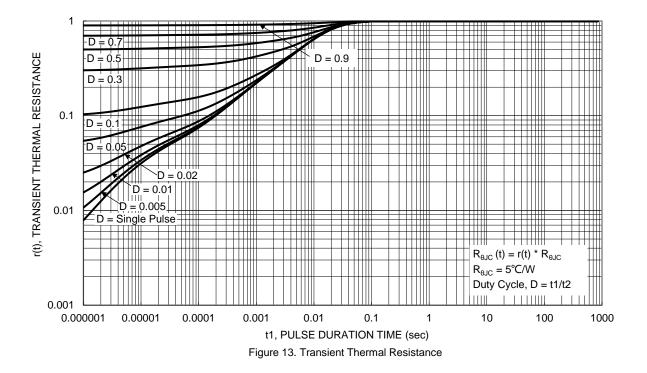
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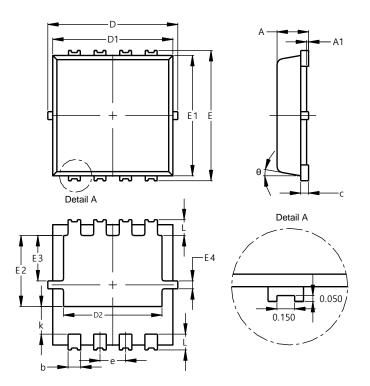






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

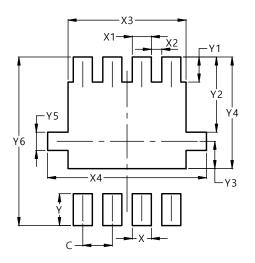


PowerDI3333-8 (SWP)						
(Type UX)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E3	0.95	1.35	1.15			
E4	<b>E4</b> 0.10 0.30 0.20					
е	-	-	0.65			
k	0.50	0.90	0.70			
L	0.30	0.50	0.40			
θ	0°	12°	10°			
All I	All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)			
С	0.650			
Х	0.420			
X1	0.420			
X2	0.230			
X3	2.600			
X4	3.500			
Y	0.700			
Y1	0.550			
Y2	1.650			
Y3	0.600			
Y4	2.450			
Y5	0.400			
Y6	3.700			



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